

Final datasheet

TRENCHSTOP™ IGBT 7 PR7 Reverse Conducting IGBT for boost PFC stage with improved EMI characteristics offering the best-in-class performance for high power and high switching frequency applications

Features

- $V_{CE} = 670\text{ V}$
- $I_C = 50\text{ A}$
- Pin-to-pin creepage distance > 4.8 mm
- Pin-to-pin clearance distance > 3.4 mm
- Optimized monolithic diode for PFC applications
- Improved EMI behavior with lower dv/dt
- Very low $V_{CEsat} = 1.4\text{ V}$ (typ.) at 25°C
- Stable temperature behavior
- Low temperature dependence of V_{CEsat} and E_{sw}
- 2 kV ESD HBM compliant
- Easy parallel switching capability based on positive temperature coefficient of V_{CEsat}
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

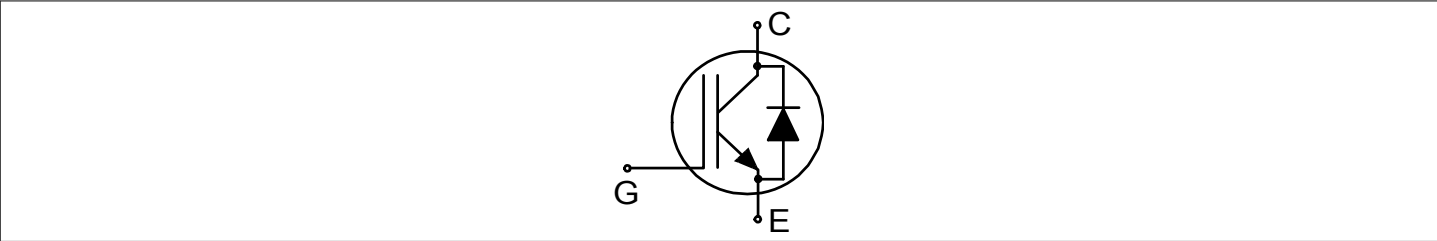
Potential applications

- Residential Aircon / Commercial Aircon
- Residential HVAC / Commercial HVAC

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description



Type	Package	Marking
IKWH50N67PR7	PG-TO247-3-U04	H50EPR7

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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.61	0.79	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		670	V
DC collector current, limited by T_{vjmax}	I_C		$T_c = 25\text{ °C}$	105	A
			$T_c = 100\text{ °C}$	65	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			150	A
Turn-off safe operating area		$V_{CE} \leq 670\text{ V}, T_{vj} \leq 175\text{ °C}$		150	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 0.5\text{ }\mu\text{s}, D < 0.001$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	246	W
			$T_c = 100\text{ °C}$	123	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 50\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		1.4	1.75	V
			$T_{vj} = 175\text{ °C}$		1.7		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Gate-emitter threshold voltage	V_{GEth}	$I_C = 0.285 \text{ mA}$, $V_{CE} = V_{GE}$	3.2	3.95	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 670 \text{ V}$, $V_{GE} = 0 \text{ V}$			40	mA
				0.5		mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = 20 \text{ V}$			100	nA
Transconductance	g_{fs}	$I_C = 50 \text{ A}$, $V_{CE} = 20 \text{ V}$		77.6		S
Input capacitance	C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		2846		pF
Output capacitance	C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		36.4		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$		14.2		pF
Gate charge	Q_G	$V_{CC} = 520 \text{ V}$, $I_C = 50 \text{ A}$, $V_{GE} = 15 \text{ V}$		127		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	18		ns
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	18		
Rise time (inductive load)	t_r	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	19		ns
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	17		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	182		ns
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	206		
Fall time (inductive load)	t_f	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	32		ns
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	46		
Turn-on energy	E_{on}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	0.98		mJ
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	1.57		
Turn-off energy	E_{off}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 9.8 \Omega$, $R_{G(off)} = 9.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	0.56		mJ
			$T_{vj} = 175 \text{ }^\circ\text{C}$, $I_C = 50 \text{ A}$	0.81		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 9.8\ \Omega$, $R_{G(off)} = 9.8\ \Omega$		1.54		mJ
				2.38		
Operating junction temperature	T_{vj}		-40		175	°C

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ °C}$	670	V
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		5	A

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Operating junction temperature	T_{vj}		-40		175	°C

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Electrical Characteristic, at $T_{vj} = 25\text{ °C}$, unless otherwise specified.

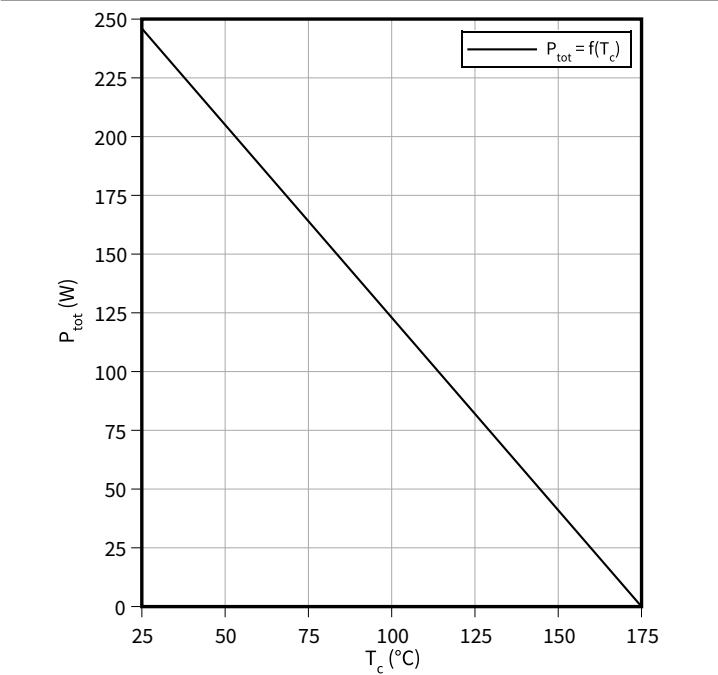
Dynamic test circuit, parasitic inductance $L_\sigma = 30\text{ nH}$, parasitic capacitor $C_\sigma = 23\text{ pF}$ from Fig. C.

2nd device for EC7 Diode = IDWD50E65E7

4 Characteristics diagrams

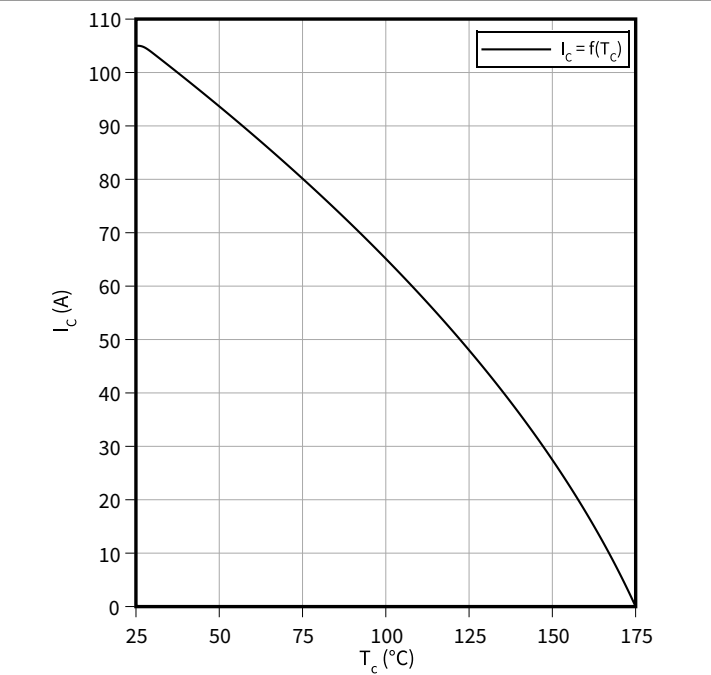
Power dissipation as a function of case temperature

$P_{\text{tot}} = f(T_c)$
 $T_{vj} \leq 175\text{ °C}$



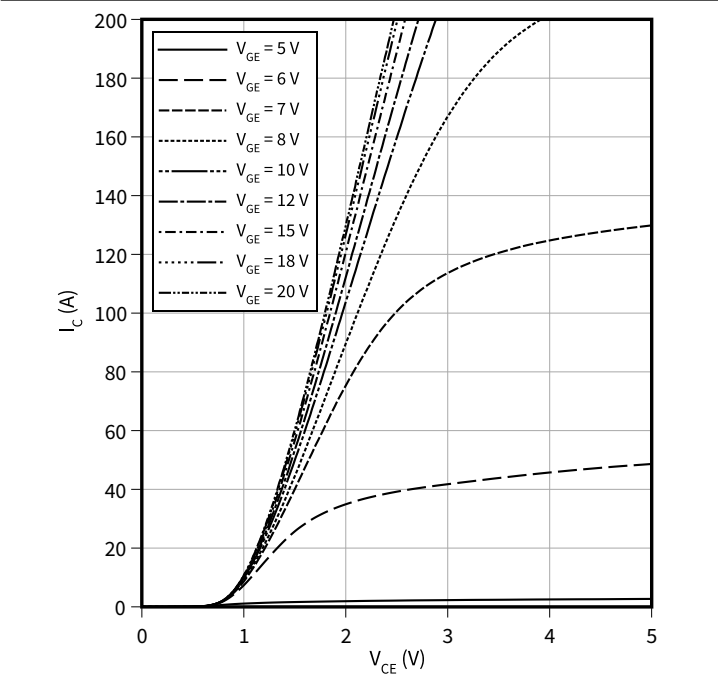
Collector current as a function of case temperature

$I_c = f(T_c)$
 $T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$



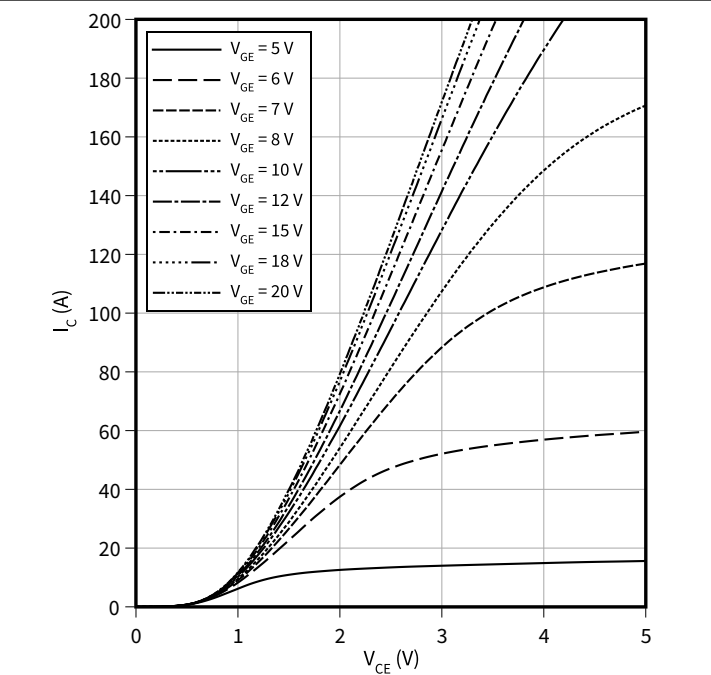
Typical output characteristic

$I_c = f(V_{CE})$
 $T_{vj} = 25\text{ °C}$



Typical output characteristic

$I_c = f(V_{CE})$
 $T_{vj} = 175\text{ °C}$

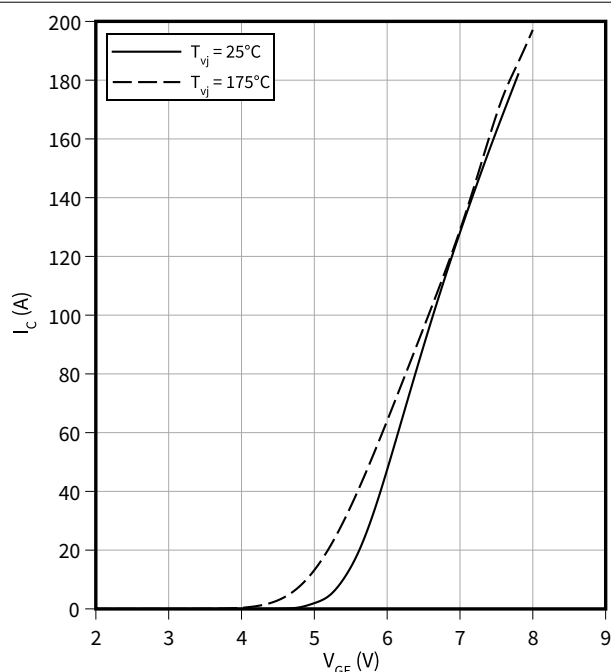


4 Characteristics diagrams

Typical transfer characteristic

$$I_C = f(V_{GE})$$

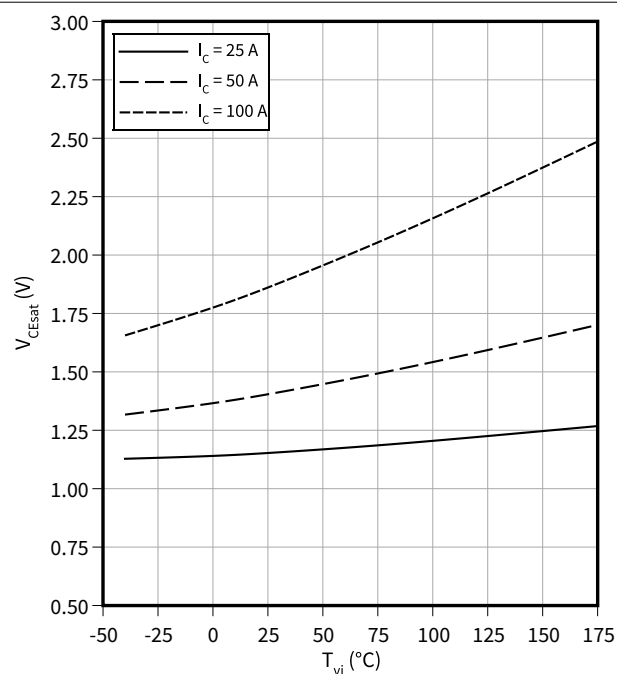
$$V_{CE} = 20 \text{ V}$$



Typical collector-emitter saturation voltage as a function of junction temperature

$$V_{CEsat} = f(T_{vj})$$

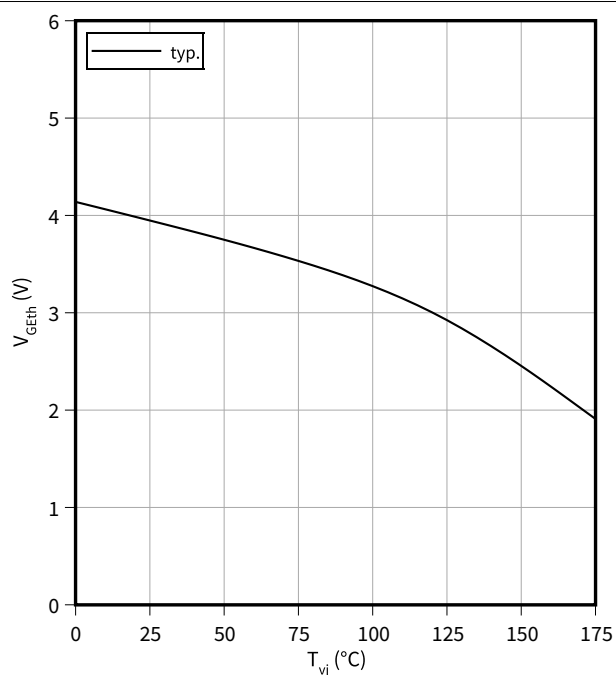
$$V_{GE} = 15 \text{ V}$$



Gate-emitter threshold voltage as a function of junction temperature

$$V_{GEth} = f(T_{vj})$$

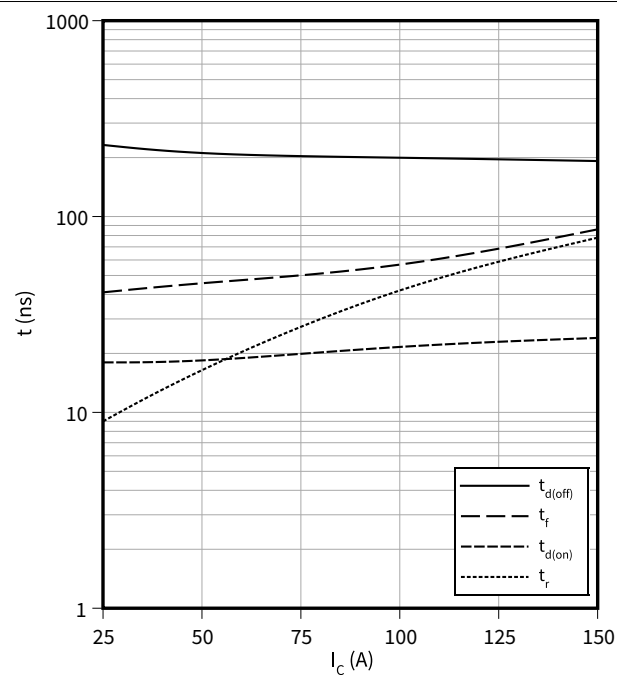
$$I_C = 0.285 \text{ mA}$$



Typical switching times as a function of collector current

$$t = f(I_C)$$

$$V_{CC} = 400 \text{ V}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 9.8 \Omega$$

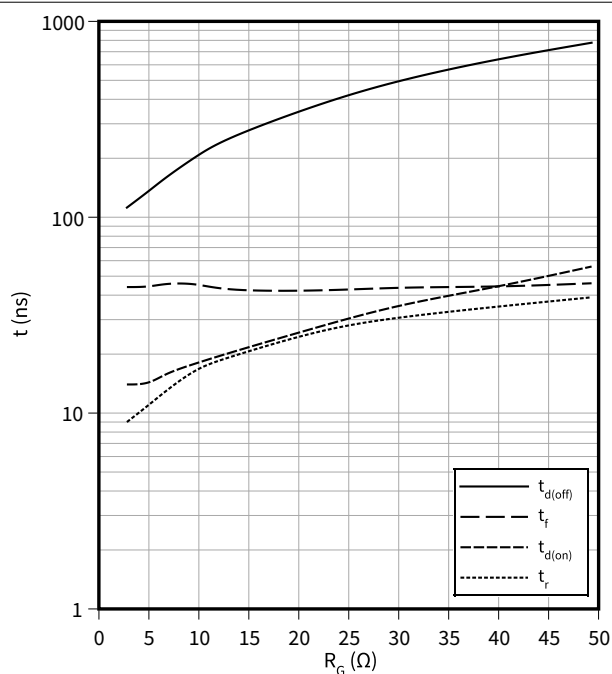


4 Characteristics diagrams

Typical switching times as a function of gate resistor

$$t = f(R_G)$$

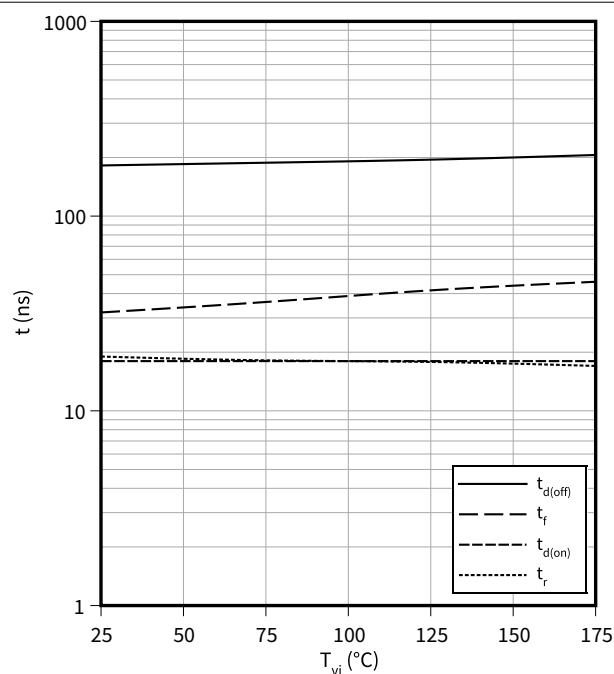
$$I_C = 50 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}$$



Typical switching times as a function of junction temperature

$$t = f(T_{vj})$$

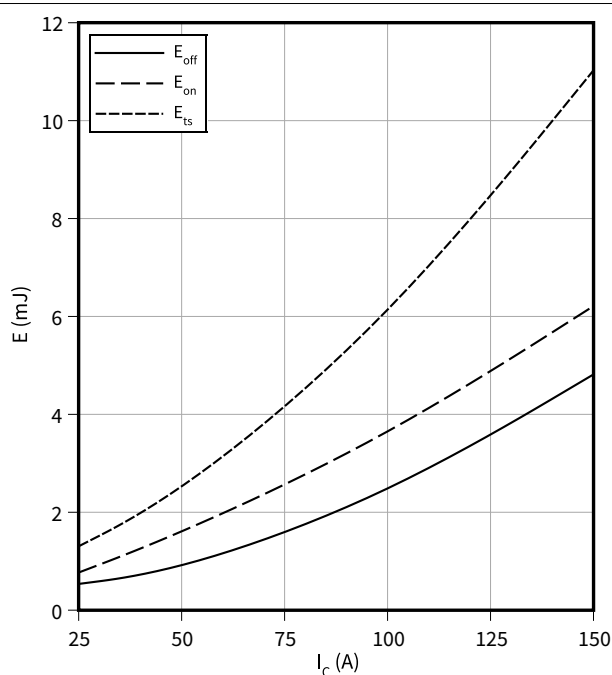
$$I_C = 50 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 9.8 \text{ } \Omega$$



Typical switching energy losses as a function of collector current

$$E = f(I_C)$$

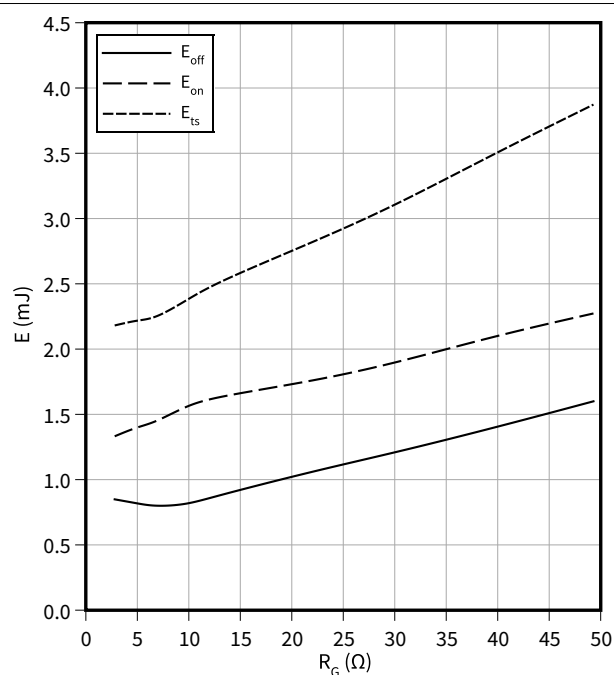
$$V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 9.8 \text{ } \Omega$$



Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

$$I_C = 50 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^\circ\text{C}, V_{GE} = 0/15 \text{ V}$$

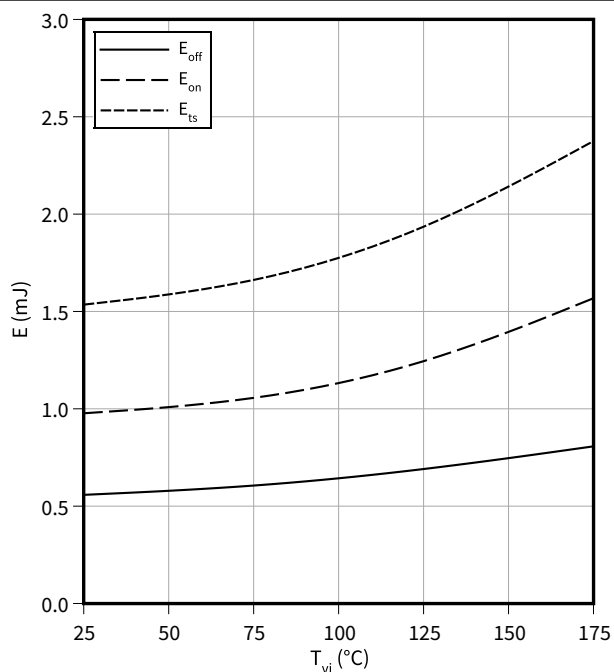


4 Characteristics diagrams

Typical switching energy losses as a function of junction temperature

$$E = f(T_{vj})$$

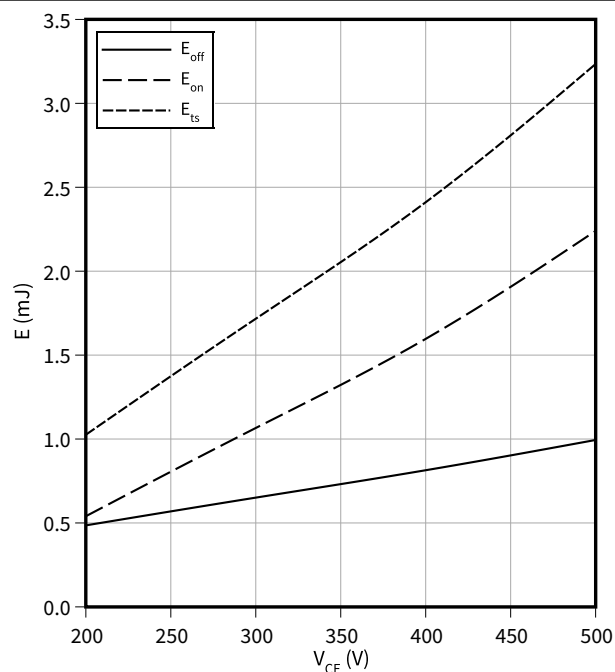
$$I_C = 50 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 9.8 \text{ } \Omega$$



Typical switching energy losses as a function of collector emitter voltage

$$E = f(V_{CE})$$

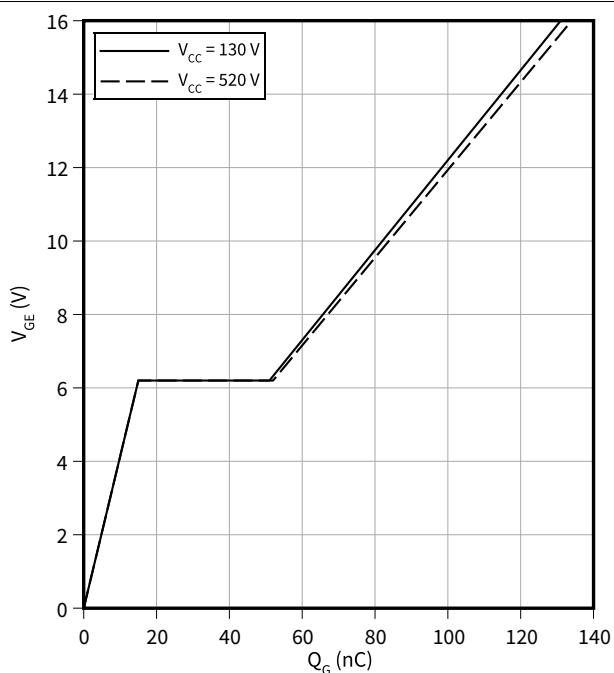
$$I_C = 50 \text{ A}, T_{vj} = 175 \text{ } ^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 9.8 \text{ } \Omega$$



Typical gate charge

$$V_{GE} = f(Q_G)$$

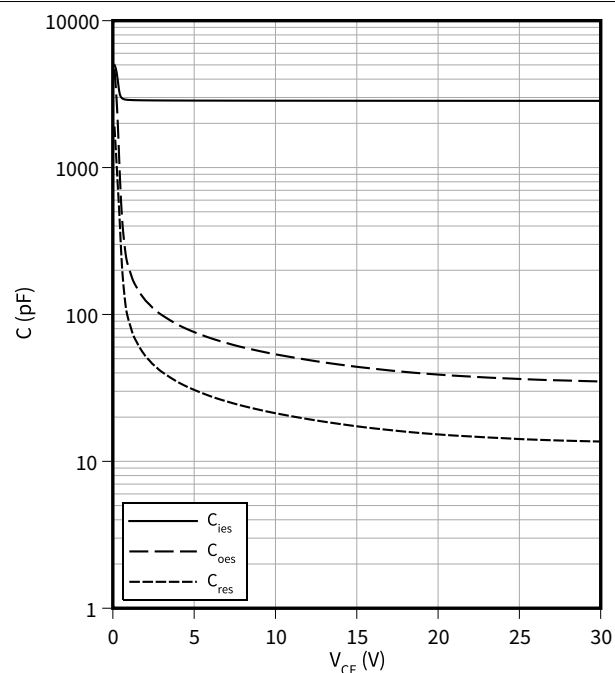
$$I_C = 50 \text{ A}$$



Typical capacitance as a function of collector-emitter voltage

$$C = f(V_{CE})$$

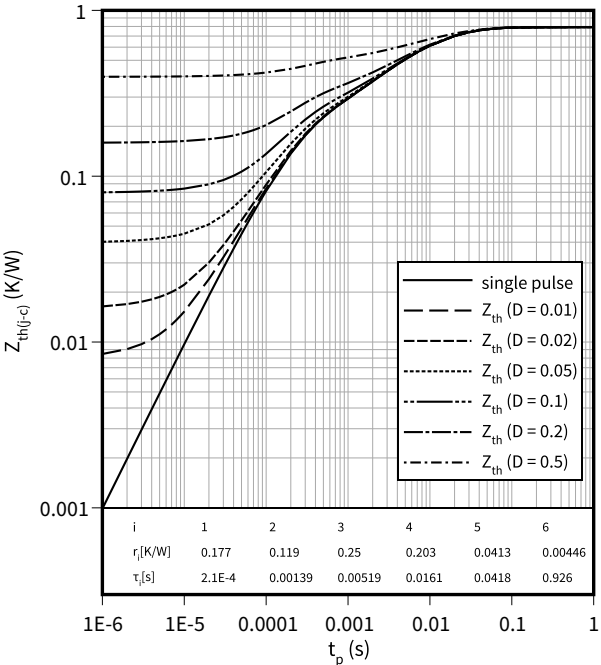
$$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$$



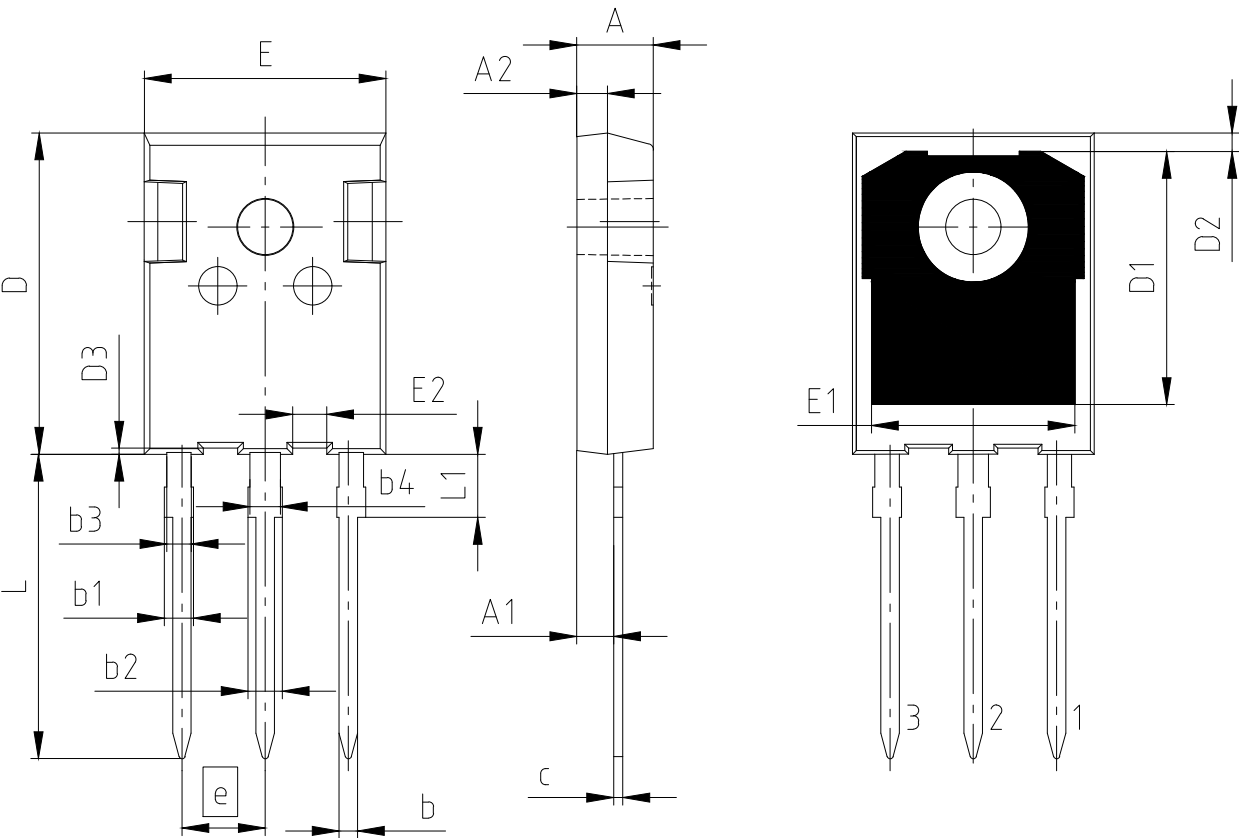
4 Characteristics diagrams

IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



5 Package outlines



PACKAGE - GROUP NUMBER: PG-TO247-3-U04		
DIMENSIONS	MILLIMETERS	
	MIN.	MAX.
A	4.90	5.10
A1	2.31	2.51
A2	1.90	2.10
b	1.16	1.26
b1		1.90
b2		2.30
b3	1.55	1.65
b4	1.96	2.06
c	0.59	0.66
D	20.90	21.10
D1	16.25	16.85
D2	1.05	1.35
D3	0.55	0.65
E	15.70	15.90
E1	13.10	13.50
E2	2.14	2.34
e	5.44	
N	3	
L	19.80	20.10
L1	3.95	4.30

Figure 1

6 Testing conditions

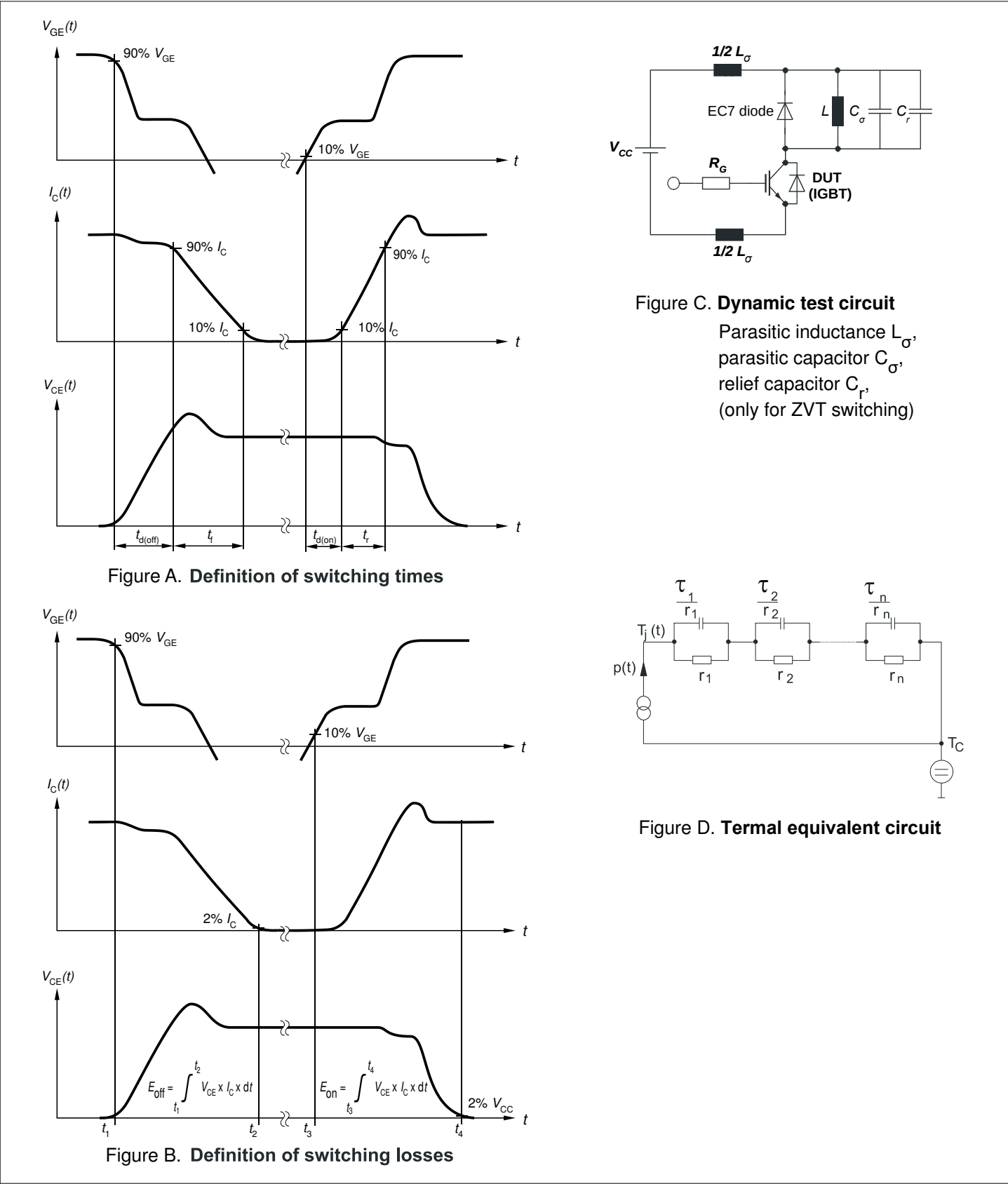


Figure 2

Document revision	Date of release	Description of changes
0.10	2024-08-13	Preliminary datasheet
1.00	2024-09-23	Final datasheet

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Edition 2024-09-23

Published by

Infineon Technologies AG

81726 Munich, Germany

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Document reference

IFX-ABJ844-002

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